



N 沟道增强型场效应晶体管 N-CHANNEL MOSFET FHA40N65W

主要参数 MAIN CHARACTERISTICS

ID	40 A
VDSS	650 V
Rdson-typ (@Vgs=10V)	0.146 Ω
Qg-typ	156 nC

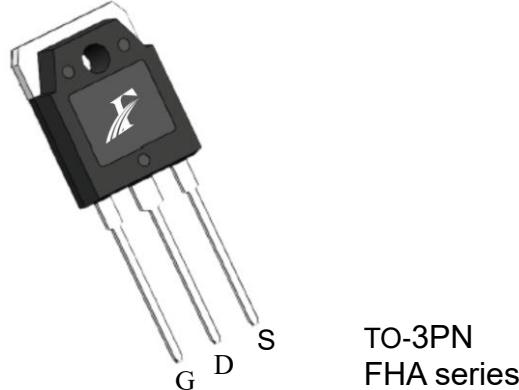
用途 APPLICATIONS

高频开关电源	High efficiency switch mode power supplies
逆变电源	Power management for inverter systems

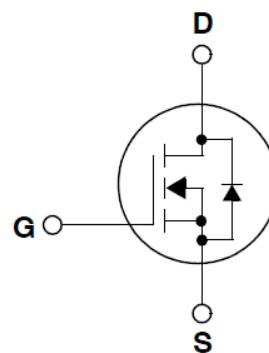
产品特性 FEATURES

低栅极电荷	Low gate charge
低 Crss (典型值 25 pF)	Low Crss (typical 25 pF)
开关速度快	Fast switching
100% 经过雪崩测试	100% avalanche tested
100% 经过热阻测试	100% DVDS tested
100% 经过 Rg 测试	100% Rg tested
高抗 dv/dt 能力	Improved dv/dt capability
平面工艺	Plane process
RoHS 产品	RoHS product

封装形式 Package



等效电路 Equivalent Circuit



绝对最大额定值 ABSOLUTE RATINGS (Tc=25°C)

项目 Parameter	符号 Symbol	数值 Value	单位 Unit
		FHA40N65W	
最高漏极—源极直流电压 Drain-Source Voltage	VDS	650	V
连续漏极电流* Drain Current -continuous *	Id (Tc=25°C)	40	A
	Id (Tc=100°C)	23	A
最大脉冲漏极电流 (注 1) Drain Current – pulse (note 1)	Idm	160	A
最高栅源电压 Gate-Source Voltage	VGS	±30	V
单脉冲雪崩能量 (注 2) Single Pulsed Avalanche Energy (note 2)	EAS	720	mJ
雪崩电流 (注 1) Avalanche Current (note 1)	IAR	12	A
重复雪崩能量 (注 1) Repetitive Avalanche Current (note 1)	EAR	90	mJ
二极管反向恢复最大电压变化速率 (注 3) Peak Diode Recovery dv/dt (note 3)	dv/dt	5.0	V/ns
耗散功率 Power Dissipation	Pd (TC=25°C)	350	W
	-Derate above 25°C	2.8	W/°C
最高结温及存储温度 Operating and Storage Temperature Range	Tj, Tstg	150, -55 to 150	°C
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes	T _L	300	°C

*漏极电流由最高结温限制

*Drain current limited by maximum junction temperature

电特性 ELECTRICAL CHARACTERISTICS

项目 Parameter	符号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units	
关态特性 Off -Characteristics							
漏一源击穿电压 Drain-Source Voltage	BV_{DSS}	$I_D=250\mu A, V_{GS}=0V$	650	-	-	V	
击穿电压温度特性 Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	$I_D=250\mu A$, referenced to 25°C	-	0.65	-	V/°C	
零栅压下漏极漏电流 Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=650V, V_{GS}=0V, T_c=25^{\circ}C$	-	-	10	μA	
		$V_{DS}=520V, T_c=125^{\circ}C$	-	-	100	μA	
栅极体漏电流 Gate-body leakage current	$I_{GSS} (F/R)$	$V_{DS}=0V, V_{GS}=\pm 30V$	-	-	± 100	nA	
通态特性 On-Characteristics							
阈值电压 Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D=250\mu A$	2.0	-	4.0	V	
静态导通电阻 Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D=20A$	-	0.146	0.18	Ω	
正向跨导 Forward Transconductance	g_{fs}	$V_{DS} = 15V, I_D=20A$ (note 4)	-	30	-	S	
动态特性 Dynamic Characteristics							
栅电阻 Gate Resistance	R_g	$f=1.0MHz, V_{DS} OPEN$	-	0.8	-	Ω	
输入电容 Input capacitance	C_{iss}	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$	-	10100	-	pF	
输出电容 Output capacitance	C_{oss}		-	600	-		
反向传输电容 Reverse transfer capacitance	C_{rss}		-	25	-		
开关特性 Switching Characteristics							
延迟时间 Turn-On delay time	$t_d(on)$	$V_{DS}=150V, I_D=20A, R_g=25\Omega, V_{GS}=10V$ (note 4, 5)	-	15	-	ns	
上升时间 Turn-On rise time	t_r		-	15	-	ns	
延迟时间 Turn-Off delay time	$t_d(off)$		-	25	-	ns	
下降时间 Turn-Off Fall time	t_f		-	10	-	ns	
栅极电荷总量 Total Gate Charge	Q_g	$V_{DS}=520V, I_D=20A, V_{GS}=10V$ (note 4, 5)	-	156	-	nC	
栅一源电荷 Gate-Source charge	Q_{gs}		-	52	-	nC	
栅一漏电荷 Gate-Drain charge	Q_{gd}		-	34	-	nC	
漏一源二极管特性及最大额定值 Drain-Source Diode Characteristics and Maximum Ratings							
正向最大连续电流 Maximum Continuous Drain-Source Diode Forward Current	I_S		-	-	40	A	
正向最大脉冲电流 Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}		-	-	160	A	
正向压降 Drain-Source Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_{SD}=40A$	-	-	1.2	V	
反向恢复时间 Reverse recovery time	t_{rr}	$V_{GS}=0V, I_S=40A, dI_F/dt=100A/\mu s$ (note 4)	-	250	-	ns	
反向恢复电荷 Reverse recovery charge	Q_{rr}		-	9.5	-	μC	

热特性 THERMAL CHARACTERISTIC

项目 Parameter	符号 Symbol	FHA40N65W	单位 Unit
结到管壳的热阻 Thermal Resistance, Junction to Case	R _{th(j-c)}	0.35	°C/W
结到环境的热阻 Thermal Resistance, Junction to Ambient	R _{th(j-A)}	40	°C/W

注释:

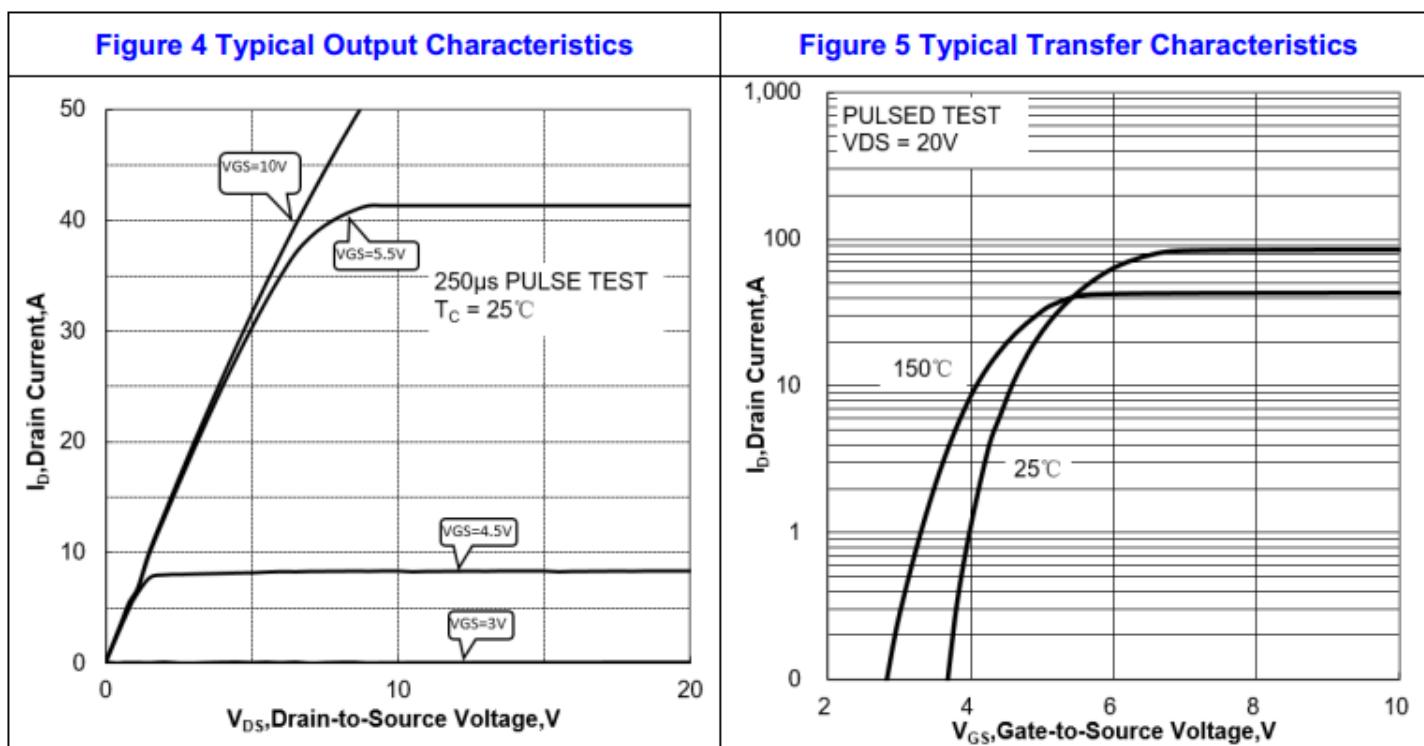
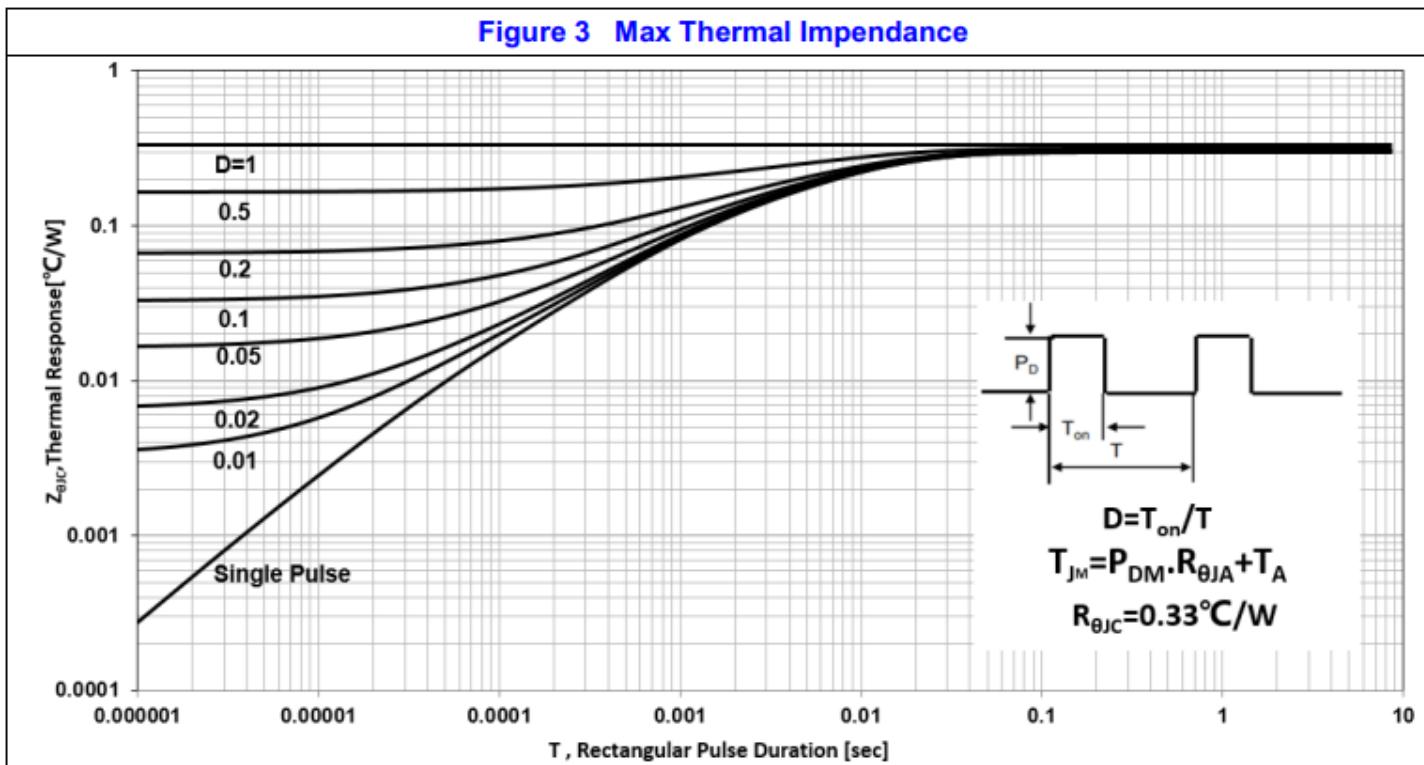
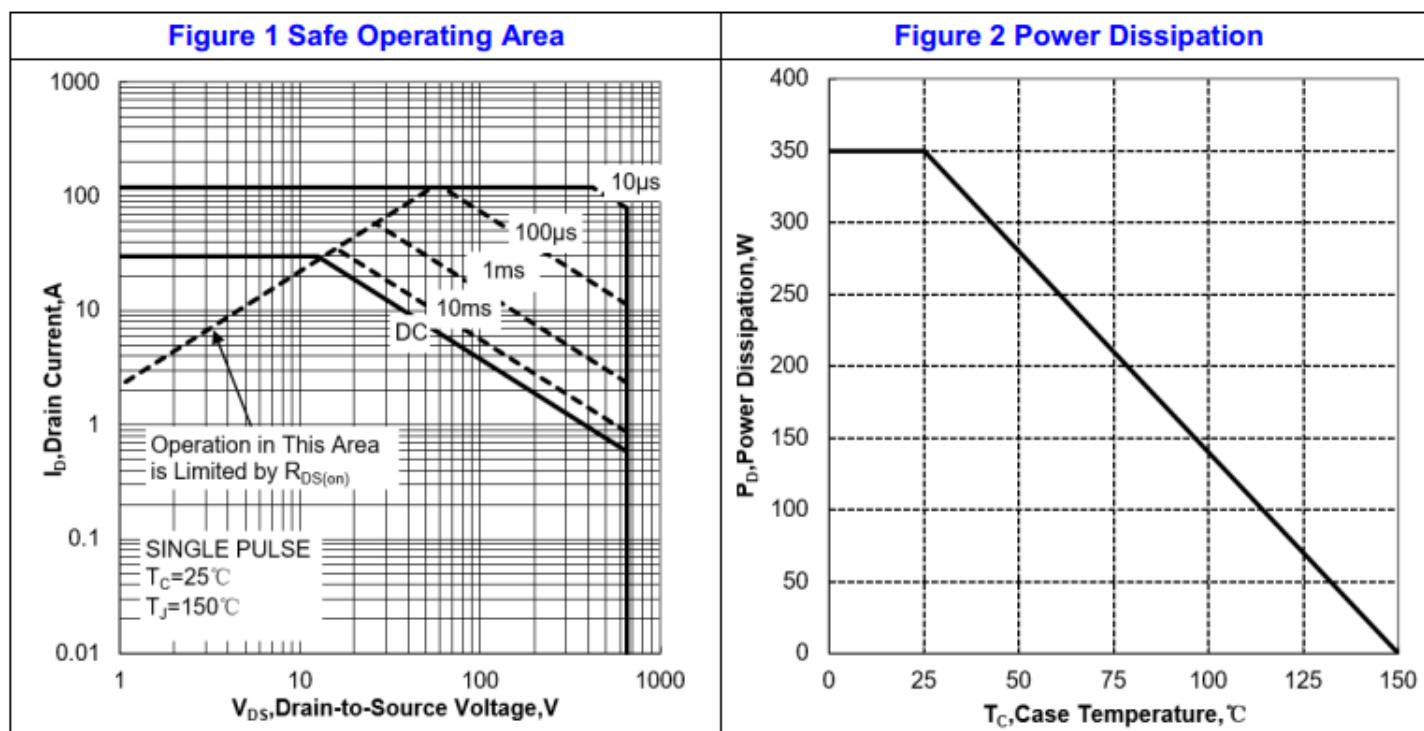
- 1: 脉冲宽度由最高结温限制
- 2: L=10mH, IAS=12A, VDD=50V, RG=25 Ω, 起始结温 TJ=25°C
- 3: ISD ≤40A, di/dt ≤200A/μs, VDD≤BV_{DSS}, 起始结温 TJ=25°C
- 4: 脉冲测试: 脉冲宽度 ≤300μs, 占空比≤2%
- 5: 基本与工作温度无关

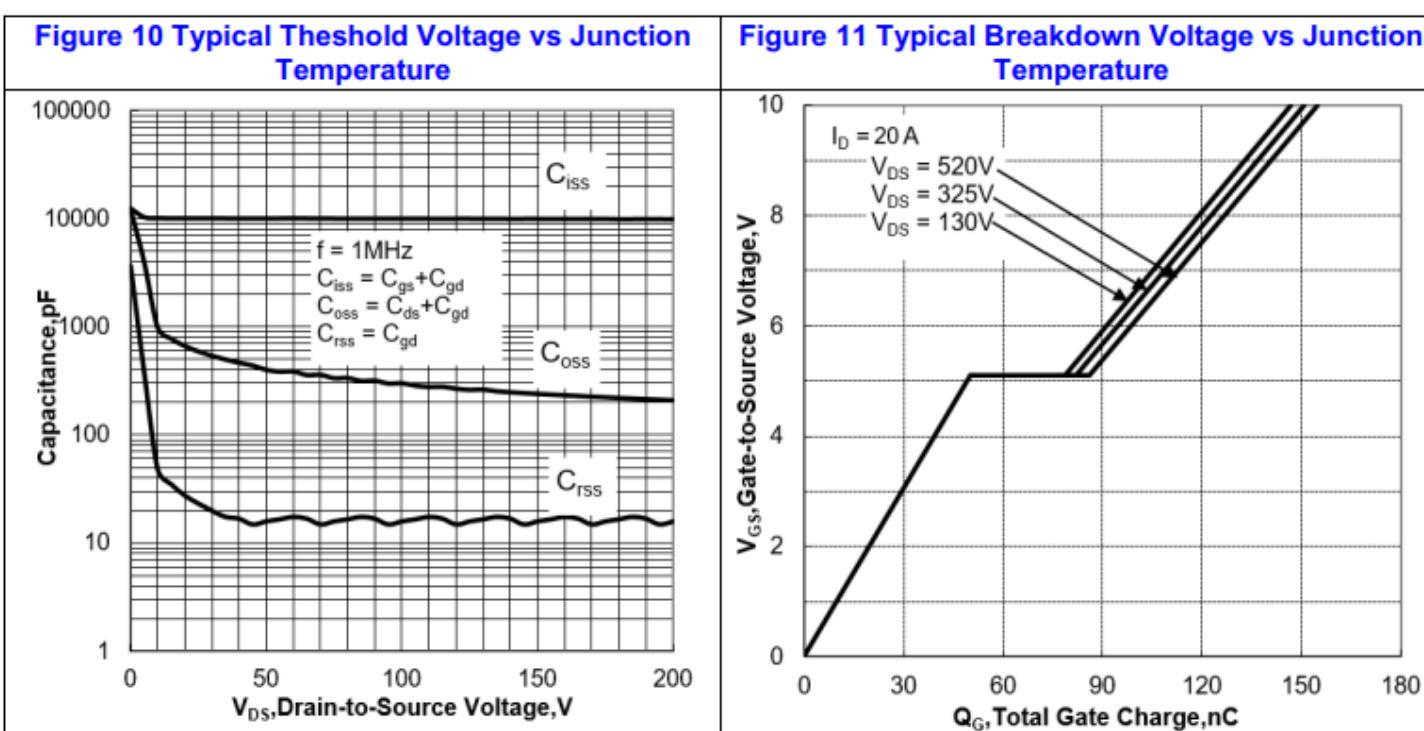
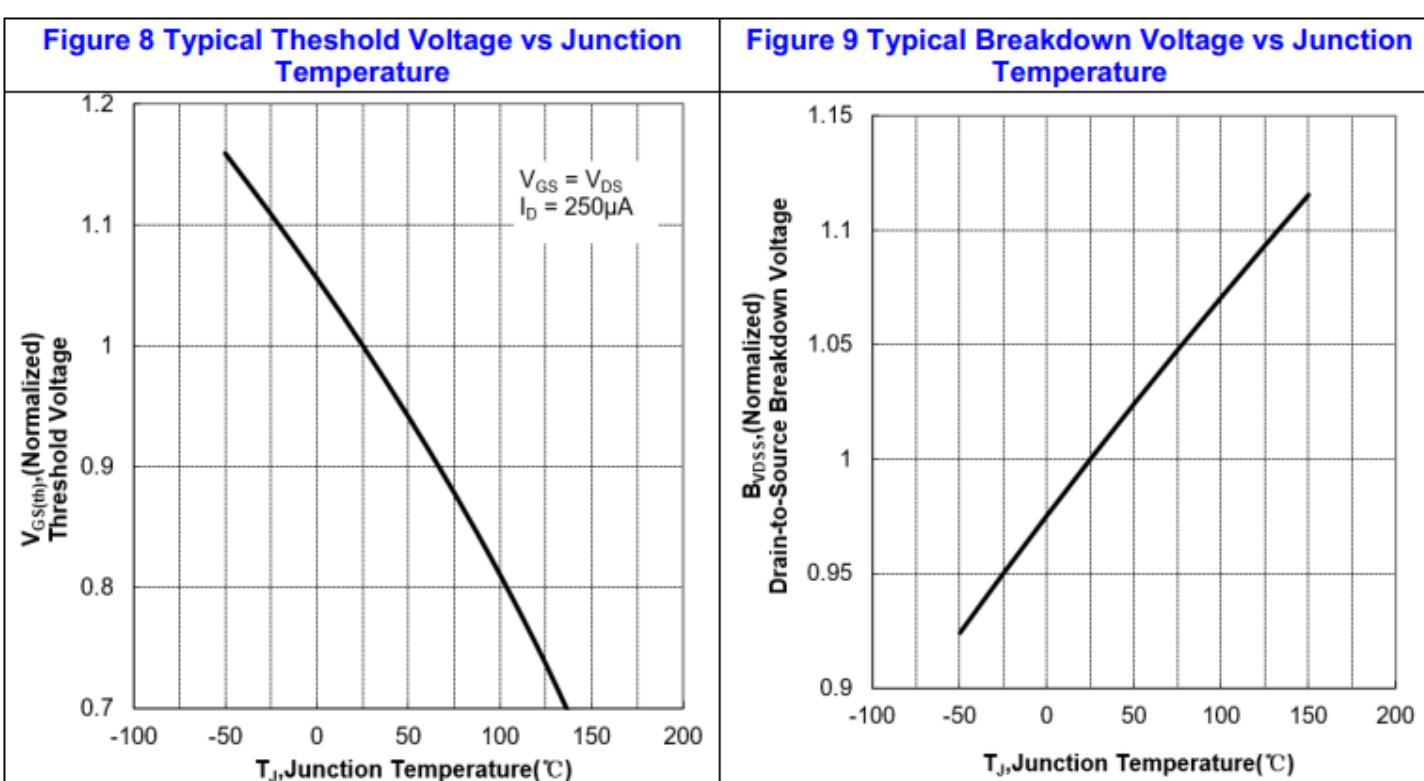
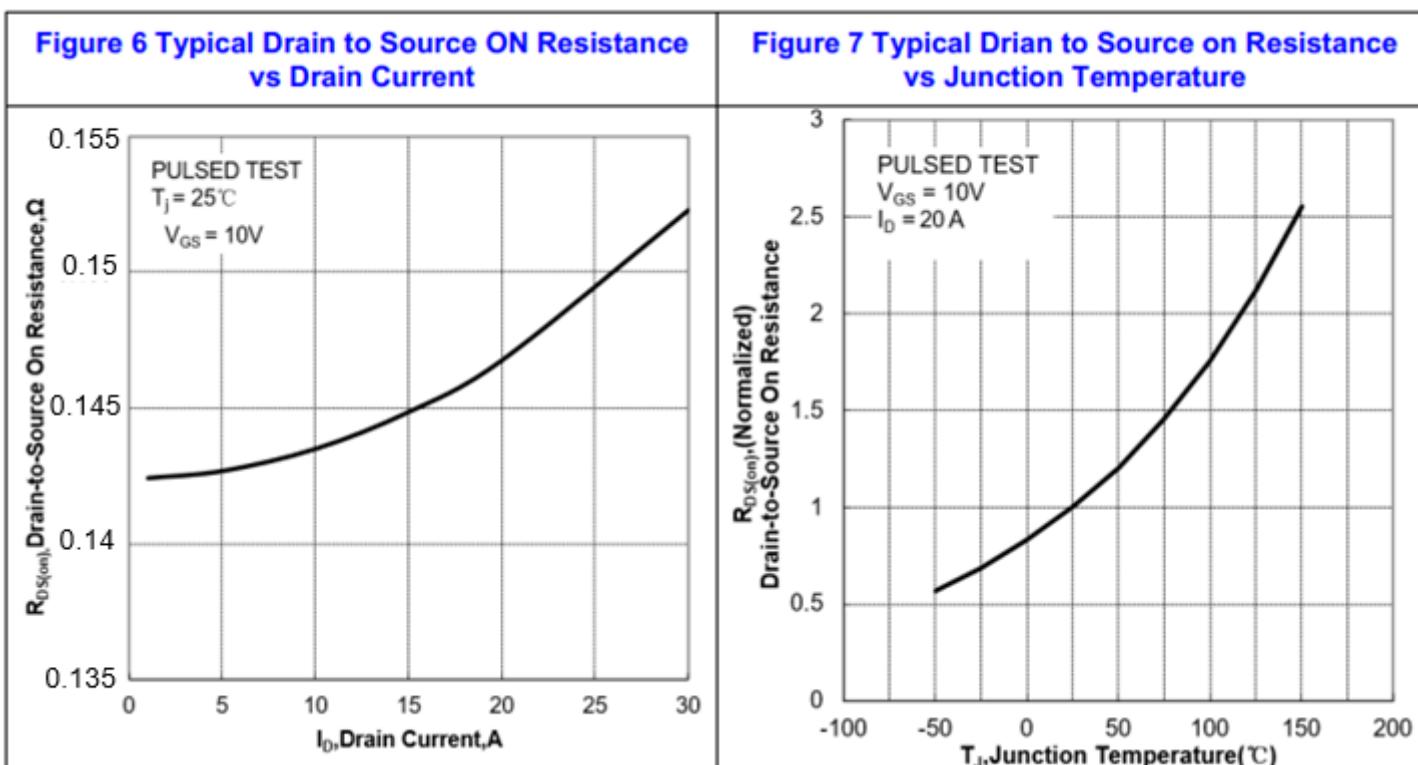
Notes:

- 1: Pulse width limited by maximum junction temperature
- 2: L=10mH, IAS=12A, VDD=50V, RG=25 Ω , Start TJ=25°C;
- 3: ISD ≤40A, di/dt ≤200A/μs, VDD≤BV_{DSS}, Starting TJ=25°C
- 4: Pulse Test: Pulse Width ≤300μs, Duty Cycle≤2%
- 5: Essentially independent of operating temperature

特性曲线

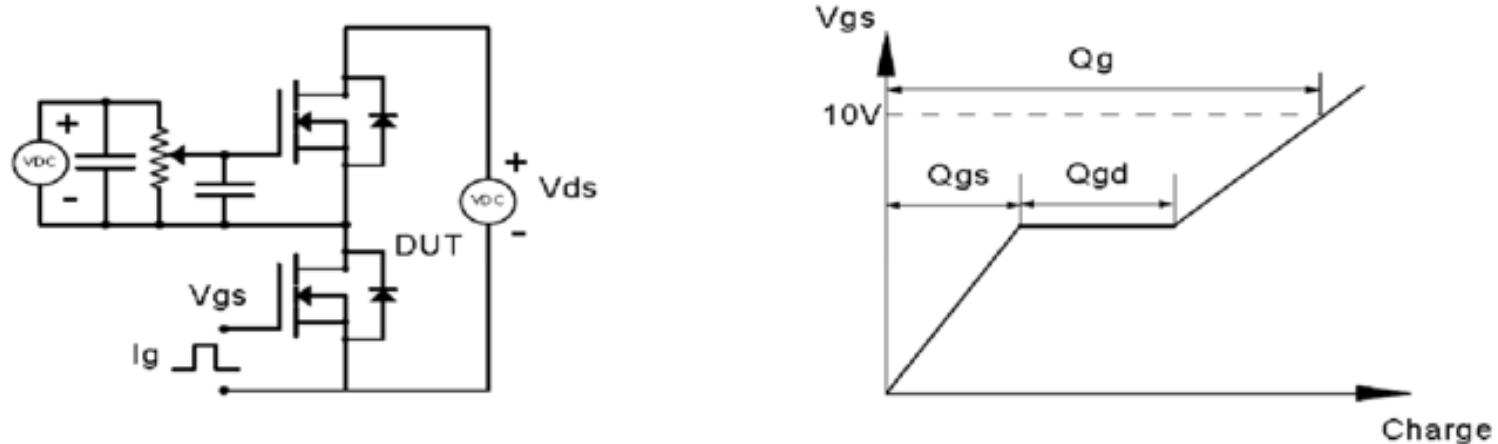
(ELECTRICAL CHARACTERISTICS (curves))



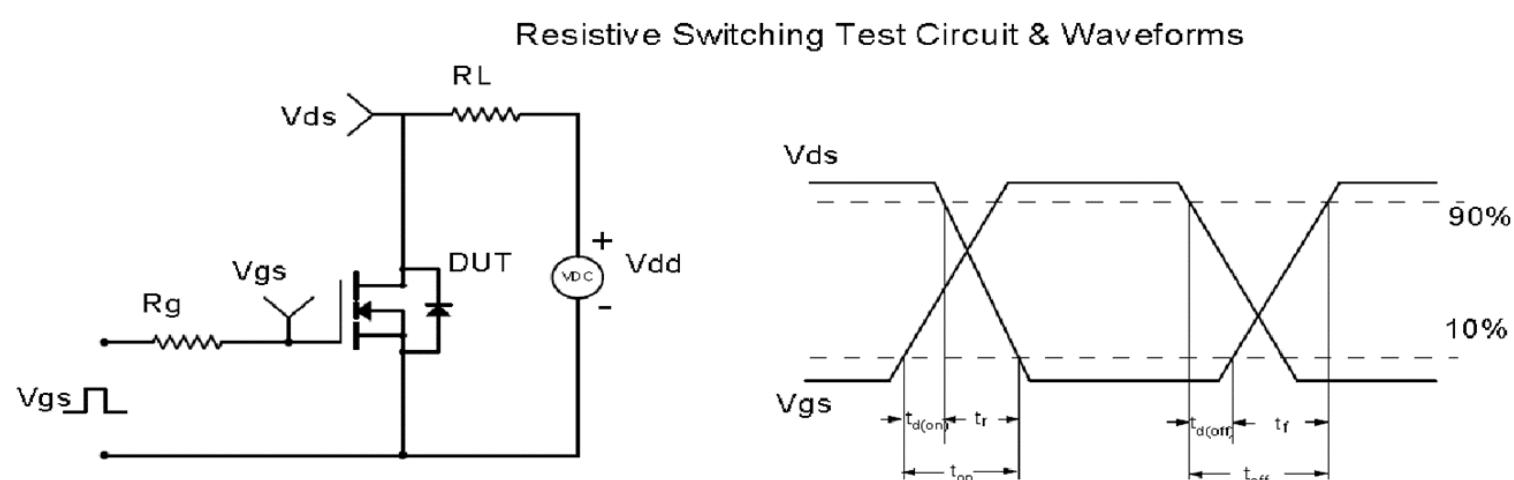


Test Circuit & Waveform

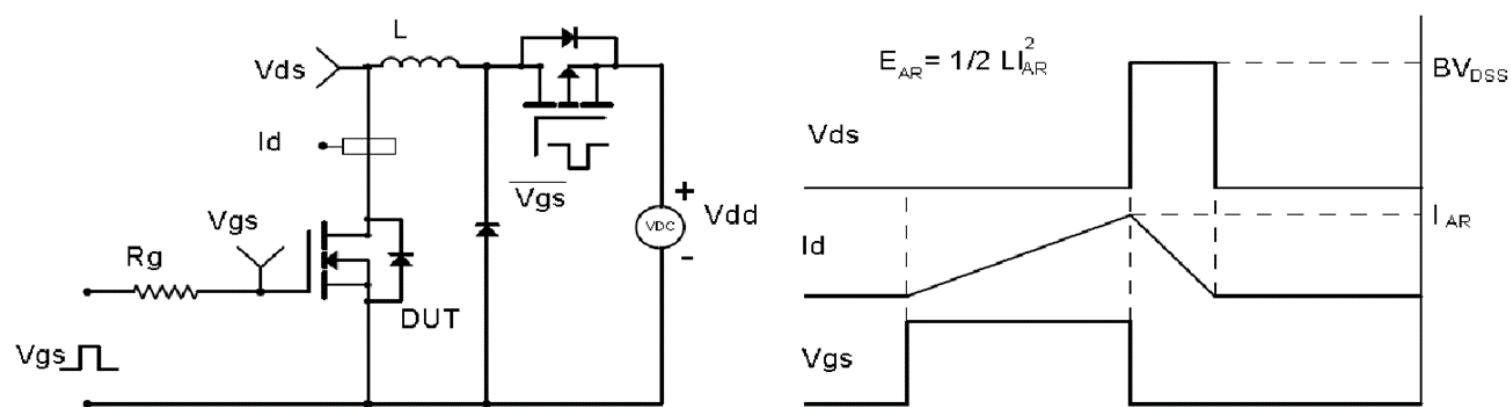
Gate Charge Test Circuit & Waveform



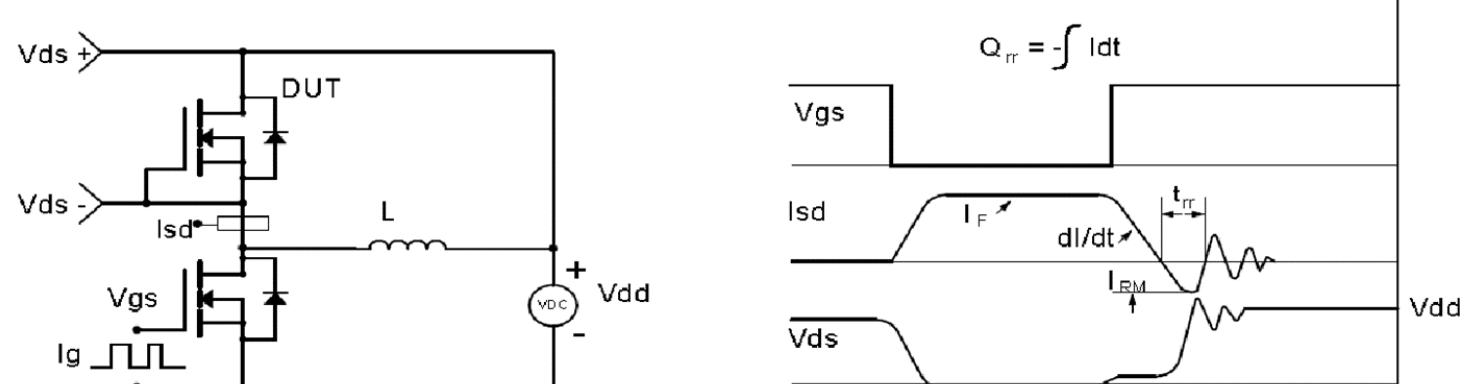
Resistive Switching Test Circuit & Waveforms



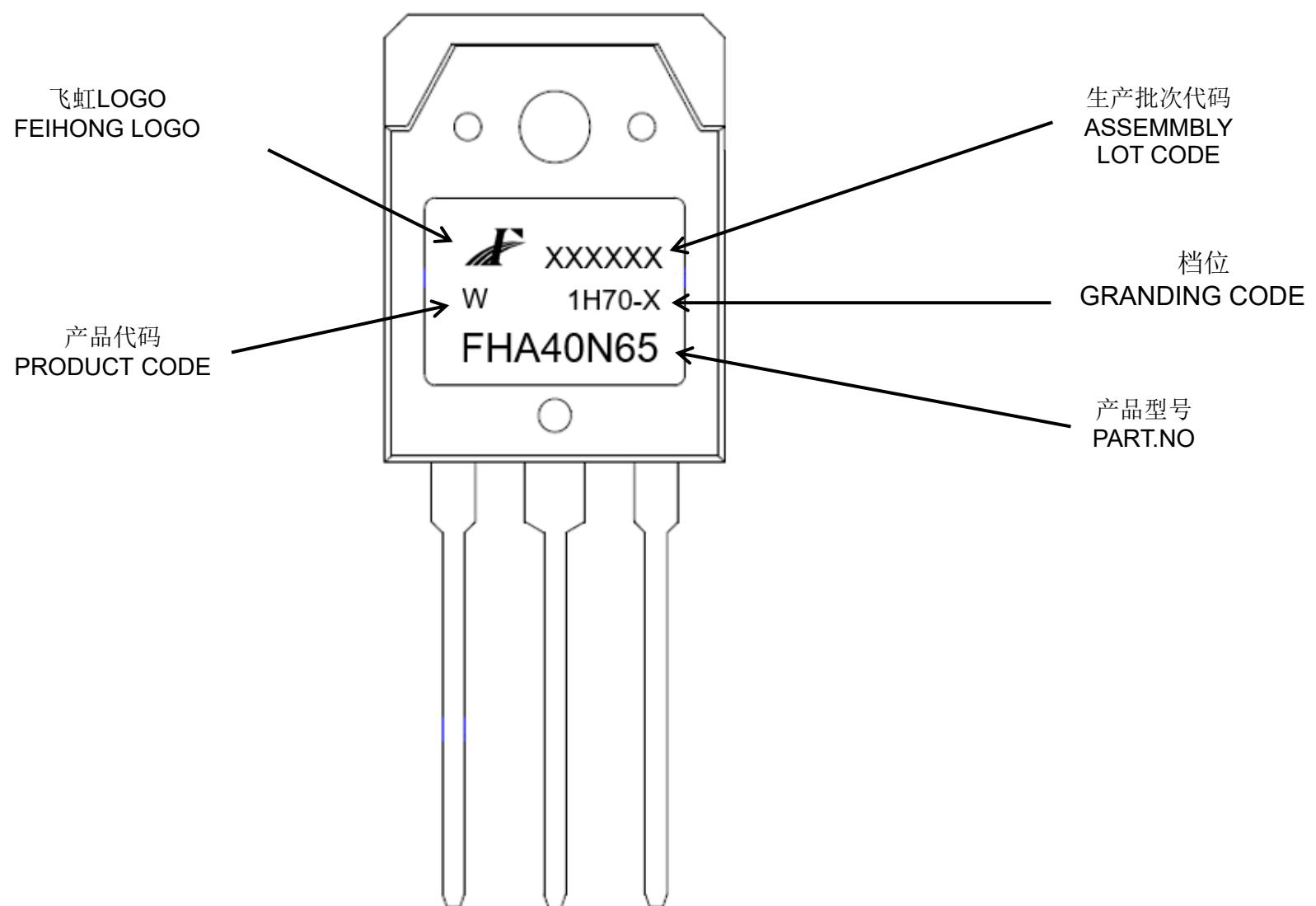
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



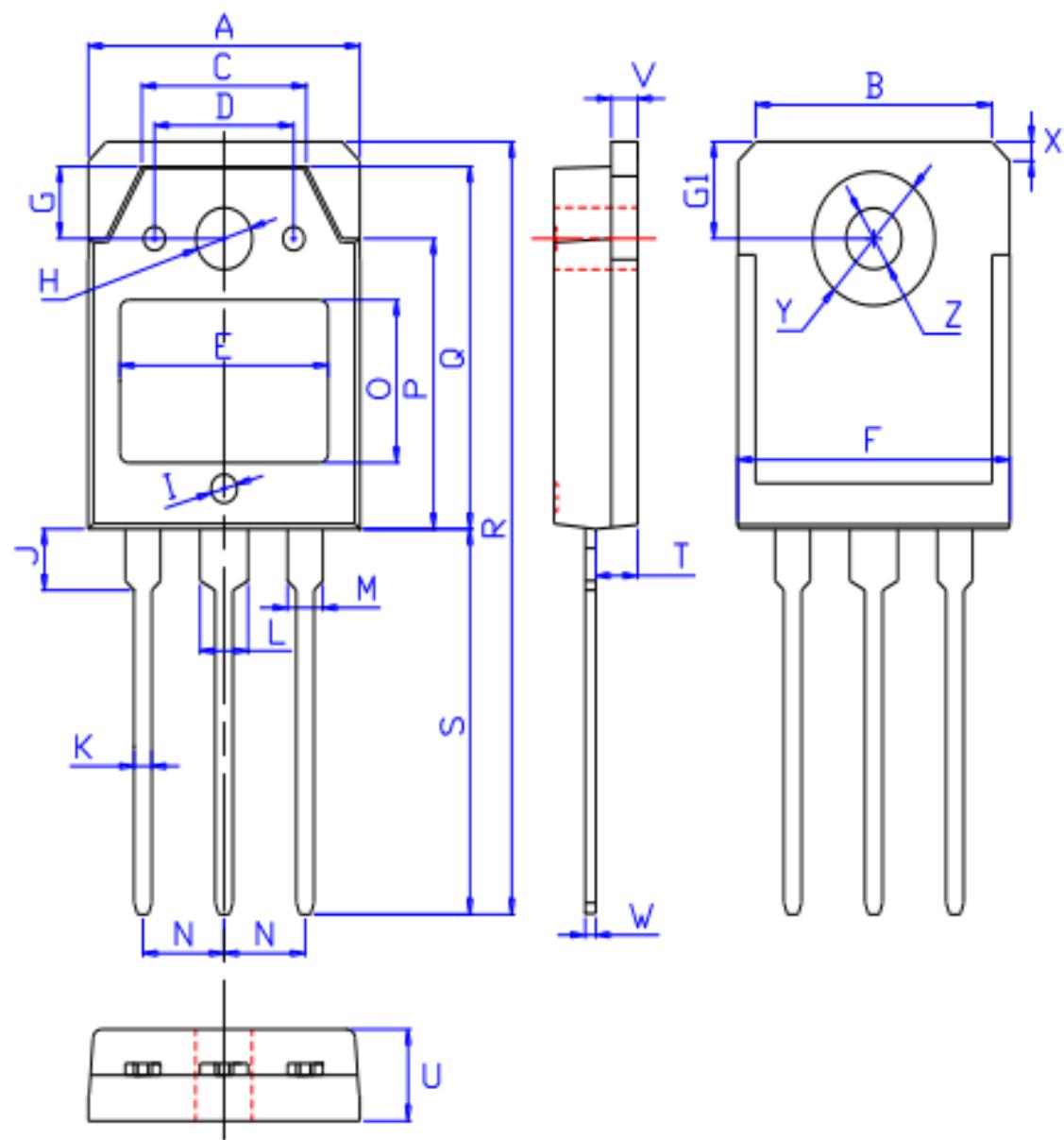
印记 Marking:



外形尺寸：

Package Dimension:

TO-3PN



DIM	MILLIMETERS
A	15.60±0.30
B	13.60±0.30
C	9.50±0.30
D	8.00±0.30
E	11.85±0.30
F	15.65±0.30
G	3.80±0.30
G1	5.00±0.30
H	Φ3.50±0.30
I	Φ1.50±0.30 深0.15±0.15
J	3.20±0.30
K	1.00±0.15
L	3.10±0.15
M	2.10±0.15
N	5.45±0.30
O	8.40±0.30
P	13.90±0.30
Q	18.70±0.30
R	40.00±0.60
S	20.00±0.40
T	2.40±0.30
U	4.80±0.30
V	1.50±0.15
W	0.60±0.15
X	1.80±0.40
Y	7.00±0.30
Z	3.20±0.30

(Units: mm)